

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	620	(infrared adj (sensor or detector)) and 250/338.1.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 13:51
L2	20	(infrared adj (sensor or detector)) and (((hot or cold) near contact) with (cover or film))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 13:51
L3	2	1 and L2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 13:51
S1	1	10/811873	US-PGPUB	OR	OFF	2005/04/17 18:36
S2	25200	(infrared adj (sensor or detector))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 13:15
S3	1891	S2 and adhesive	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/17 18:37
S4	12	S3 and (adhesive with (heat near conduct\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/17 18:41
S5	9	S4 and substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/17 18:41
S6	22	S3 and ((adhesive or bond\$4) with (heat near conduct\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/17 18:41
S7	19	S6 and substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/17 18:41

S8	92	((infrared adj (sensor or detector)) with (mount\$4 near3 substrate))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 09:51
S9	13	S8 and (heat near conduct\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 10:04
S10	5283	"6" and ((adhesive or bond\$4) with (heat near conduct\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 11:01
S11	92	((infrared adj (sensor or detector)) with (mount\$4 near3 substrate))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 10:05
S12	2	S11 and ((adhesive or bond\$4) with (heat near conduct\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 10:13
S13	4	S11 and ((adhesive or bond\$4) same (heat near conduct\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 10:17
S14	1	("4111717").PN.	USPAT	OR	OFF	2005/04/25 10:56
S15	1	"20040188618"	US-PGPUB	OR	OFF	2005/04/25 10:57
S16	25281	(infrared adj (sensor or detector))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 11:06
S17	8	S16 same ((adhesive or bond\$4) with (heat near conduct\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 11:02
S18	12	((infrared adj (sensor or detector)) same (silicon\$3 with adhesive)) and mount\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 11:06

S19	6	S18 and substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 11:06
S20	12	((infrared adj (sensor or detector)) same (silicon\$3 with adhesive)) and mount\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 11:40
S21	1	("5056929").PN.	USPAT	OR	OFF	2005/04/25 11:40
S22	20	(infrared adj (sensor or detector)) and (((hot or cold) near contact) with (cover or film))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/25 13:50